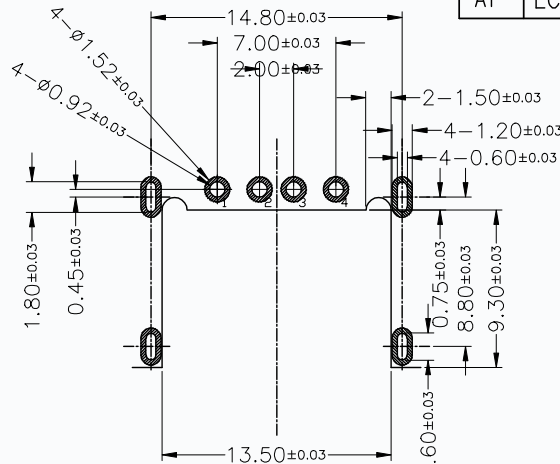
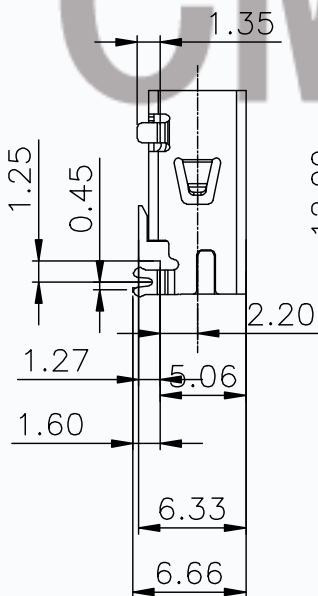
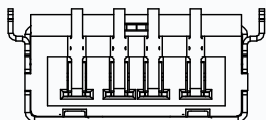
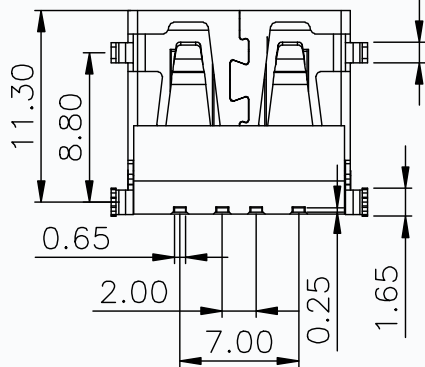
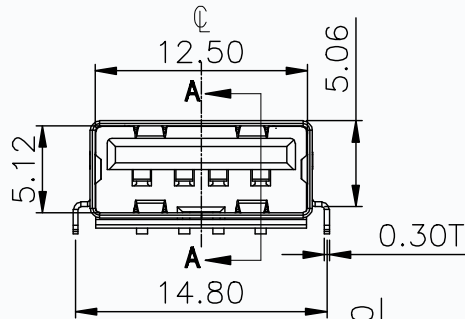
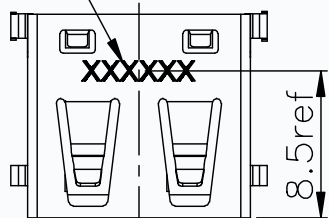
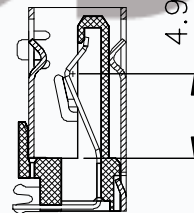
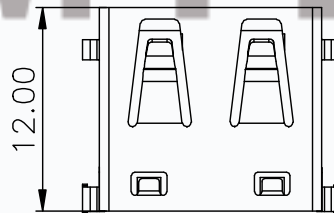


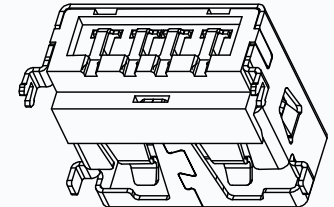
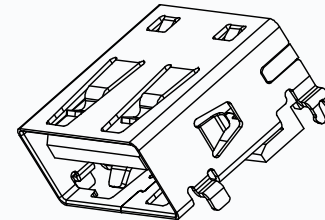
④ 喷码:年月日
[例:150522]



RECOMMENDED PCB LAYOUT (COMPONENT SIDE)
PCB THICKNESS 1.20mm(TOLERANCE+0.05mm)



SECTION A-A
SCALE 1:1



SPECIFICATIONS:
Contact current Rating:
1.5 Amperes for pin1&pin4.
Dielectric Withstanding Voltage:AC 500V(RMS)
Insulation resistance:1000Megohms Minimum.
Contact Resistance:
30mΩ Max for pin1&pin4
Mechanical Characteristics:
Mating Force:35 Newtons.Maximum
Unmating Force:10 Newtons.Minimum.
Durability :1500 CYCLES MIN
MATERIAL:
Housing:LCP+30%GF94V-0 COLOR:BLACK
Contact: copper alloy(T=0.25mm)
Shell: SUS
PLATING:
Contact: Au Plated on contact area
Tin Plated on solder area
Nickel underplating over all
Shell: Nickel Plated
operating Temperature:-55°to+85°

料号备注

T10 2 F 127 D XX R XX XX XX

R=PACK-R0001

01=半金亮锡10"
12=半金亮锡10"
13=半金亮锡30"
14=半金亮锡60"
15=半金亮锡160"
16=半金亮锡300"

00=LCP黑 不锈钢壳镀镍

R=ROHS2.0标准
F=无卤+ROHS2.0
H=REACH标准

B=盐雾24H
C=盐雾48H

东莞市田都科技有限公司
DONGGUAN TIANDU TECHNOLOGY CO.,LTD

UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL	日期	品名规格	USB 2.0 AF 90° DIP (沉板式 12.0 TYPE)	
X.	+/-	制图	2014.02.22	料号	SEE TABLE	
.X	+/-	审核	2014.02.22			
.XX	+/-	核准	2014.02.22			
FRACTIONS +/-		文件位置		字库	工程图号:	版本
ANGLES +/-		ANGLE OF PROJECTION		A4	DWG-USBAF-149	A1
DIMENSIONS				比例	1 : 1	状态码 A 页数 1 OF 1
(METRIC)	(MM)					